1 FW/AF

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

SEP 0 9 2008

Art Unit: 2892 Examiner: Mr. William F. Kraig

re PATENT APPLICATION of:

Applicant	:	Akira TAKAHASHI)	
Serial No.	:	10/798,482	A RATERIERA ATERIA
Filed	:	March 12, 2004	AMENDMENT AFTER FINAL REJECTION
For	:	DRY ETCHING METHOD FOR SEMICONDUCTOR DEVICE)	
Attorney Ref.	:	OKI 414)	September 9, 2008

Mail Stop AF

Director of Patents
P.O. Box 1450
Alexandria VA 2231

Alexandria, VA 22313-1450

Sir:

This is responsive to the Office Action of June 9, 2008, the period for reply to which has been set to expire on September 9, 2008.

A fee of \$\int_{\int_{\infty}} \int_{\infty} \text{ is also being submitted concurrently. Should this remittance be accidentally missing, however, or should any additional fees be needed, the Director may charge such fees to our Deposit Account number 18-0002.

Please amend the above-identified application as specified on the following pages, and then reconsider the application in view of the Remarks that are presented thereafter.